

U.S. PATENT AND TRADEMARK OFFICE
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



PATENT

410/FID
7/16/2
Walk

In re Application of:

Moon et al.

Serial No.: 09/874,631

Filed: June 5, 2001

For: FLEXIBLE BALL GRID ARRAY CHIP
SCALE PACKAGES AND METHODS OF
FABRICATION

Examiner: S. Clark

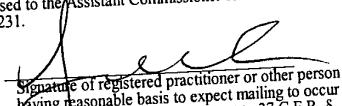
Group Art Unit: 2815

Attorney Docket No.: 4368US (99-0959)

CERTIFICATE OF MAILING

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1.8(a)(1)(ii)

Joseph A. Walkowski
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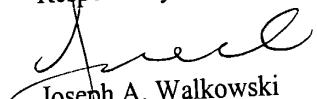
TRANSMITTAL OF FORMAL DRAWINGS

Commissioner for Patents
Washington, D.C. 20231

Sir:

Attached please find corrected formal drawings for this application.

Respectfully submitted,


Joseph A. Walkowski
Registration No. 28,765

Attorney for Applicants

TRASKBRITT, PC

P. O. Box 2550

Salt Lake City, Utah 84110-2550

Telephone: (801) 532-1922

Date: June 28, 2002

JAW/dlm

N:22694368Transmittal of Frml Dwgs.wpd

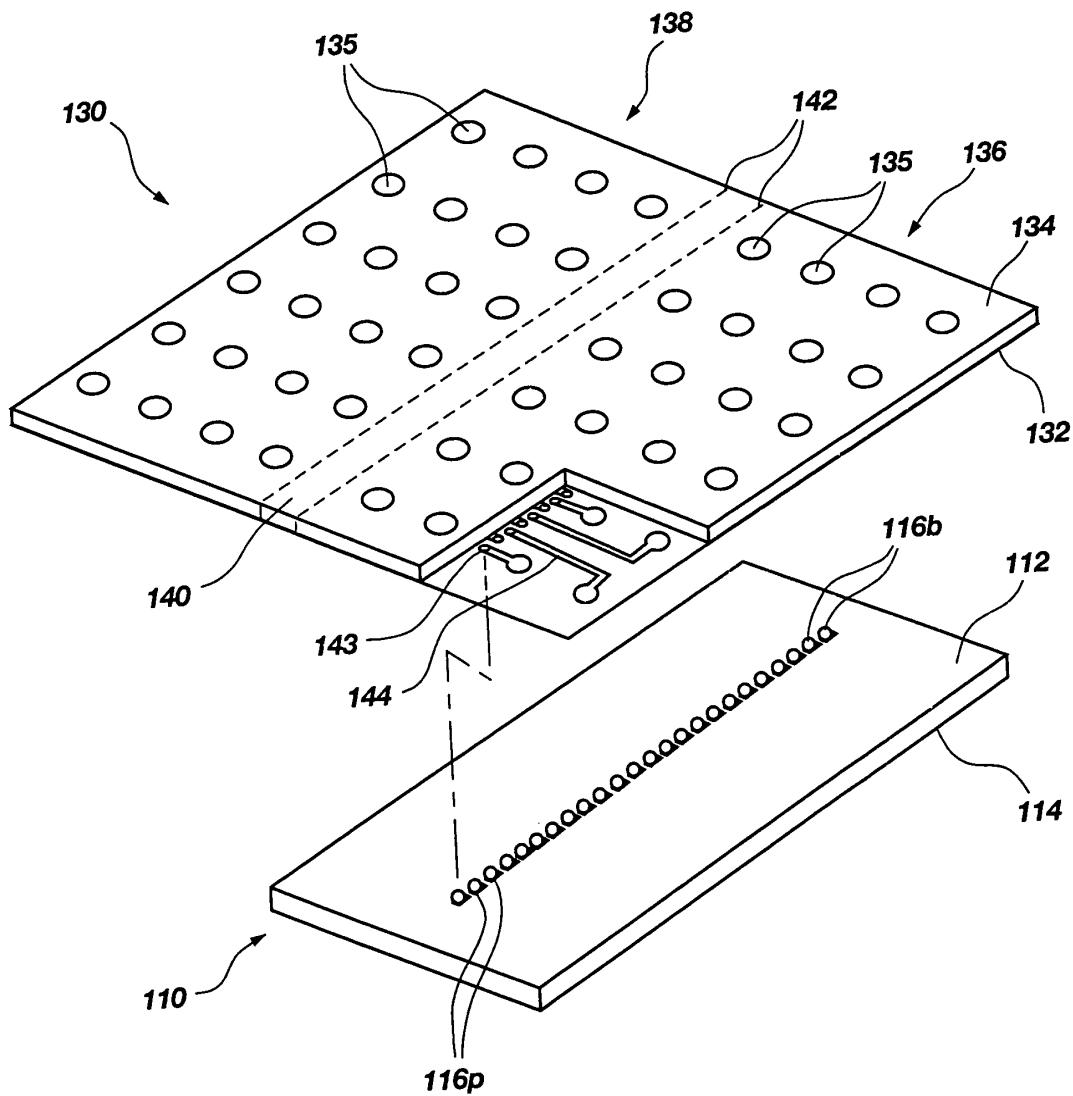


Fig. 1(a)

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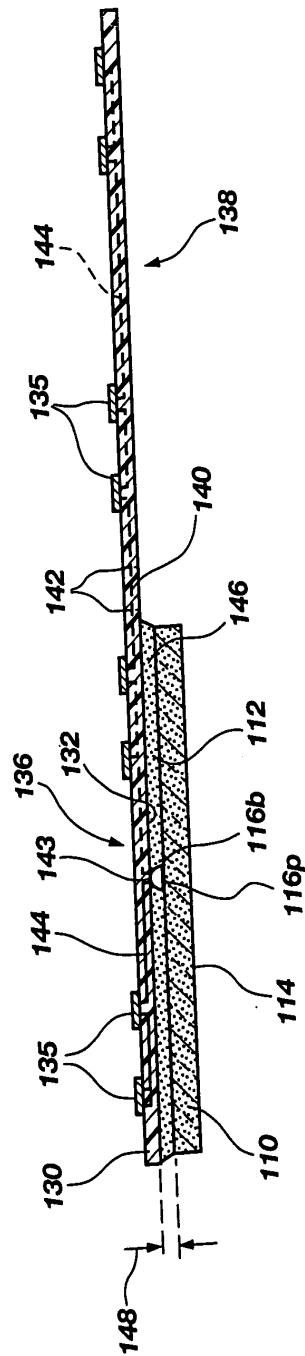


Fig. 1(b)

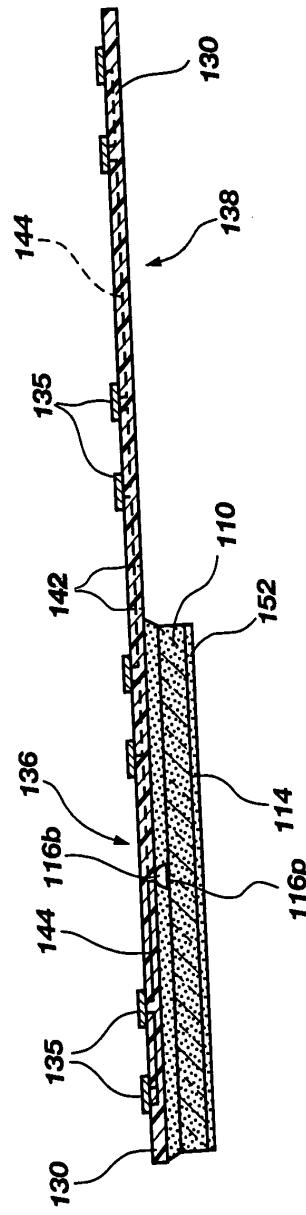


Fig. 1(c)

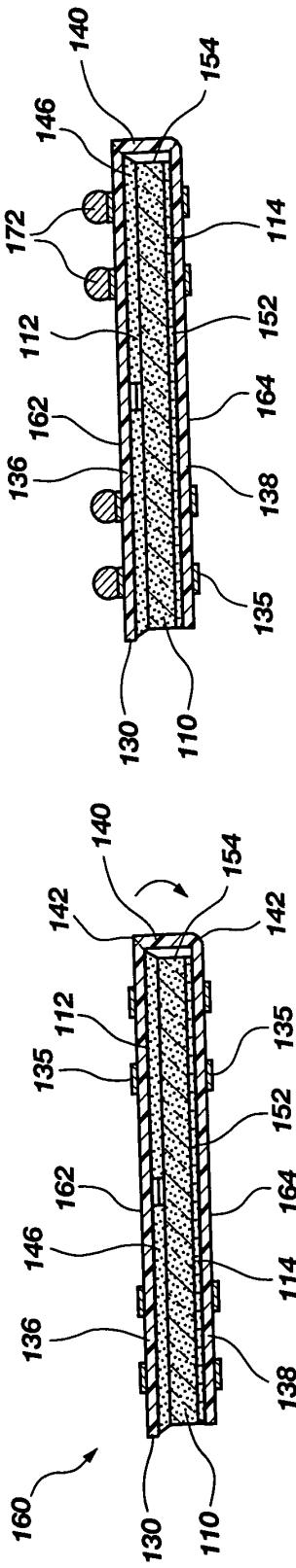


Fig. 1(e)

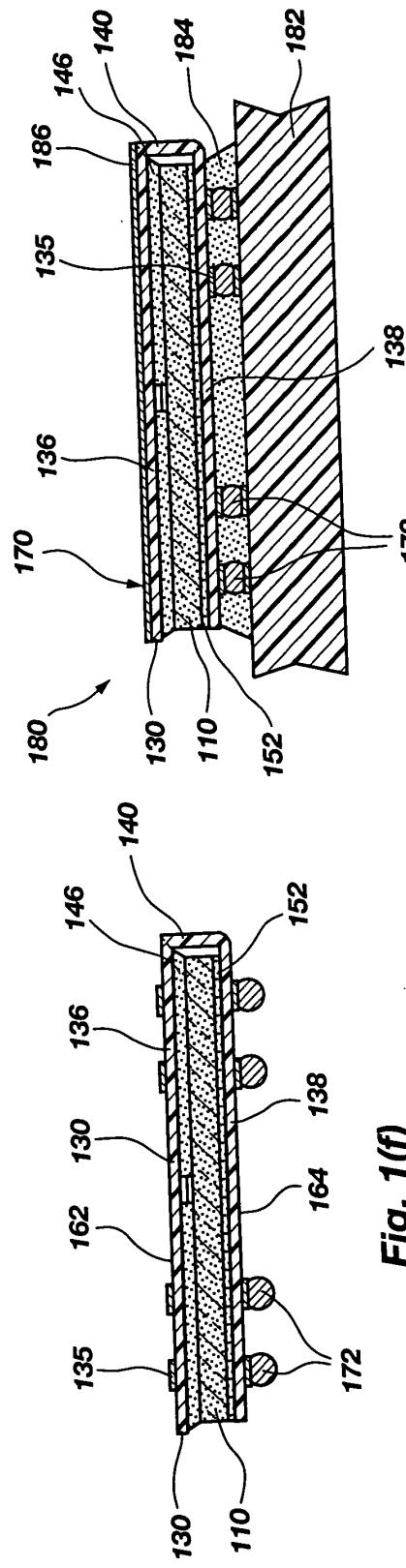


Fig. 1(g)

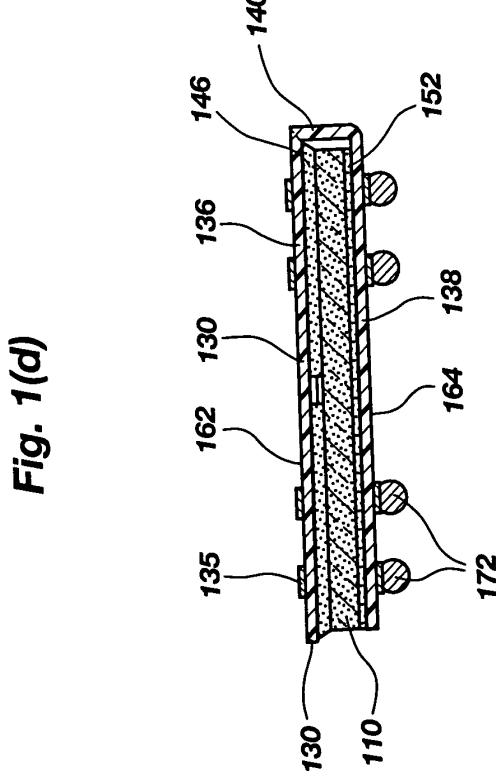


Fig. 1(f)

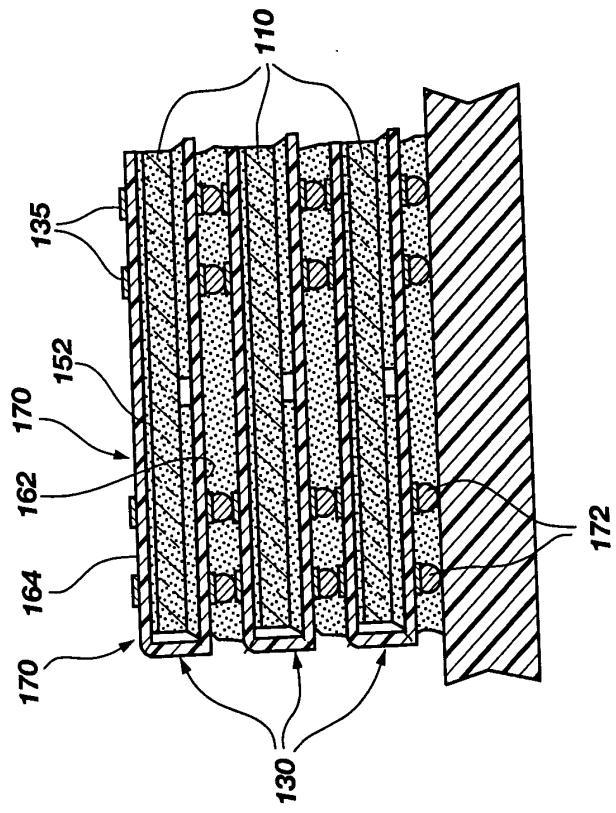


Fig. 2(b)

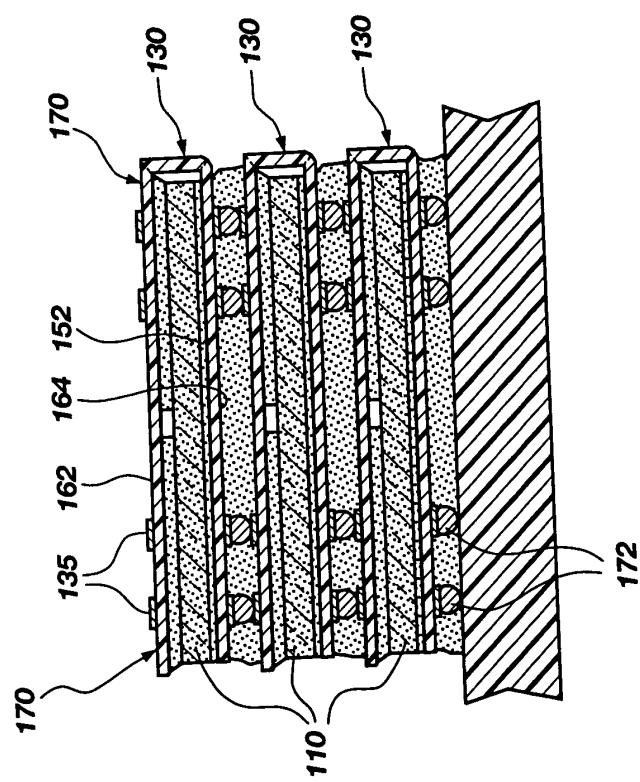


Fig. 2(a)

**TITLE: FLEXIBLE BALL GRID ARRAY CHIP SCALE PACKAGES AND
METHODS OF FABRICATION**

Inventor: Moon et al.
Serial No.: 09/874,631
Docket No.: 2269-4368US

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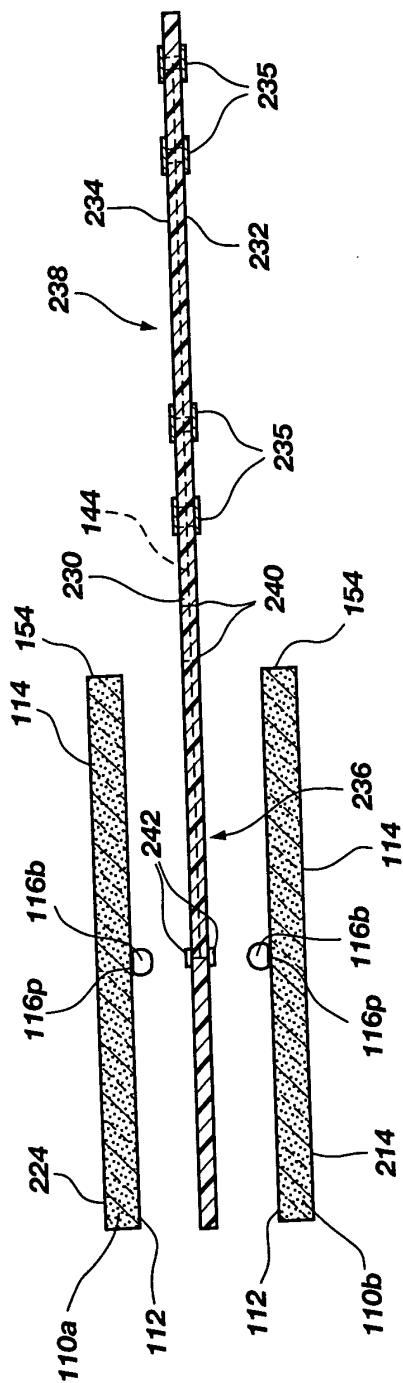


Fig. 3(a)

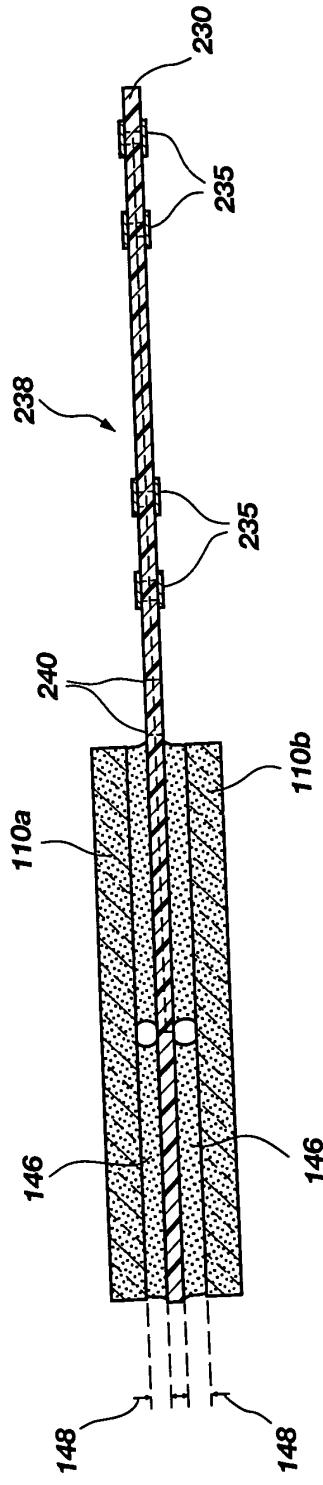


Fig. 3(b)

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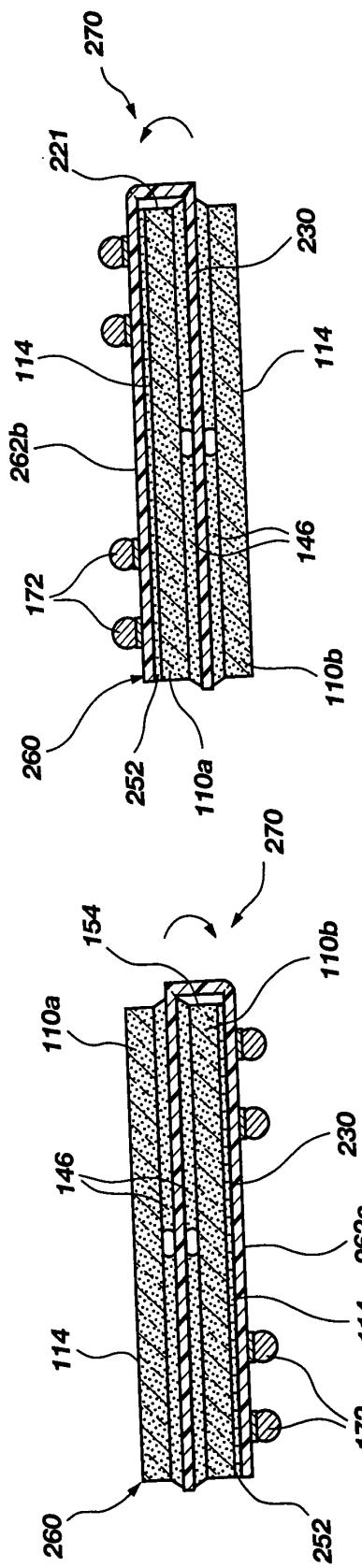


Fig. 3(d)

Fig. 3(c)

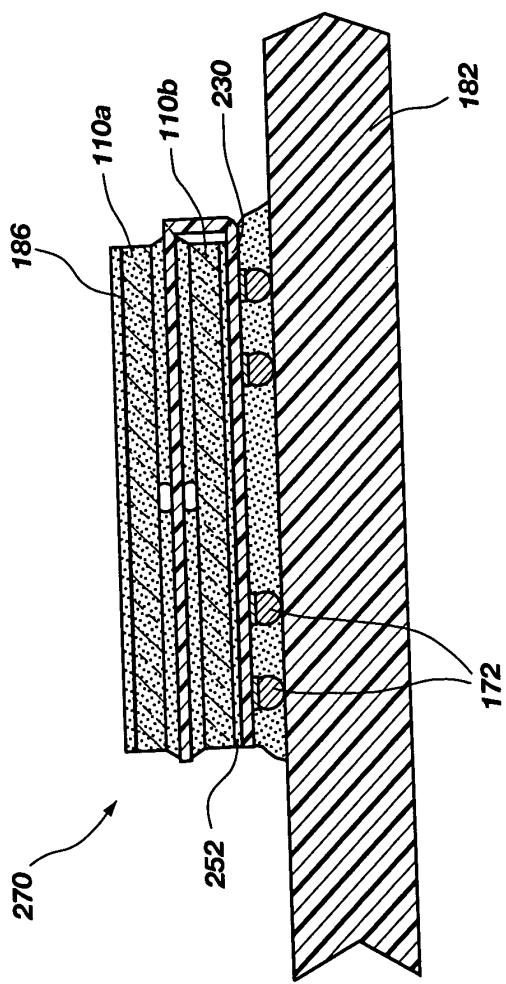


Fig. 3(e)

8078

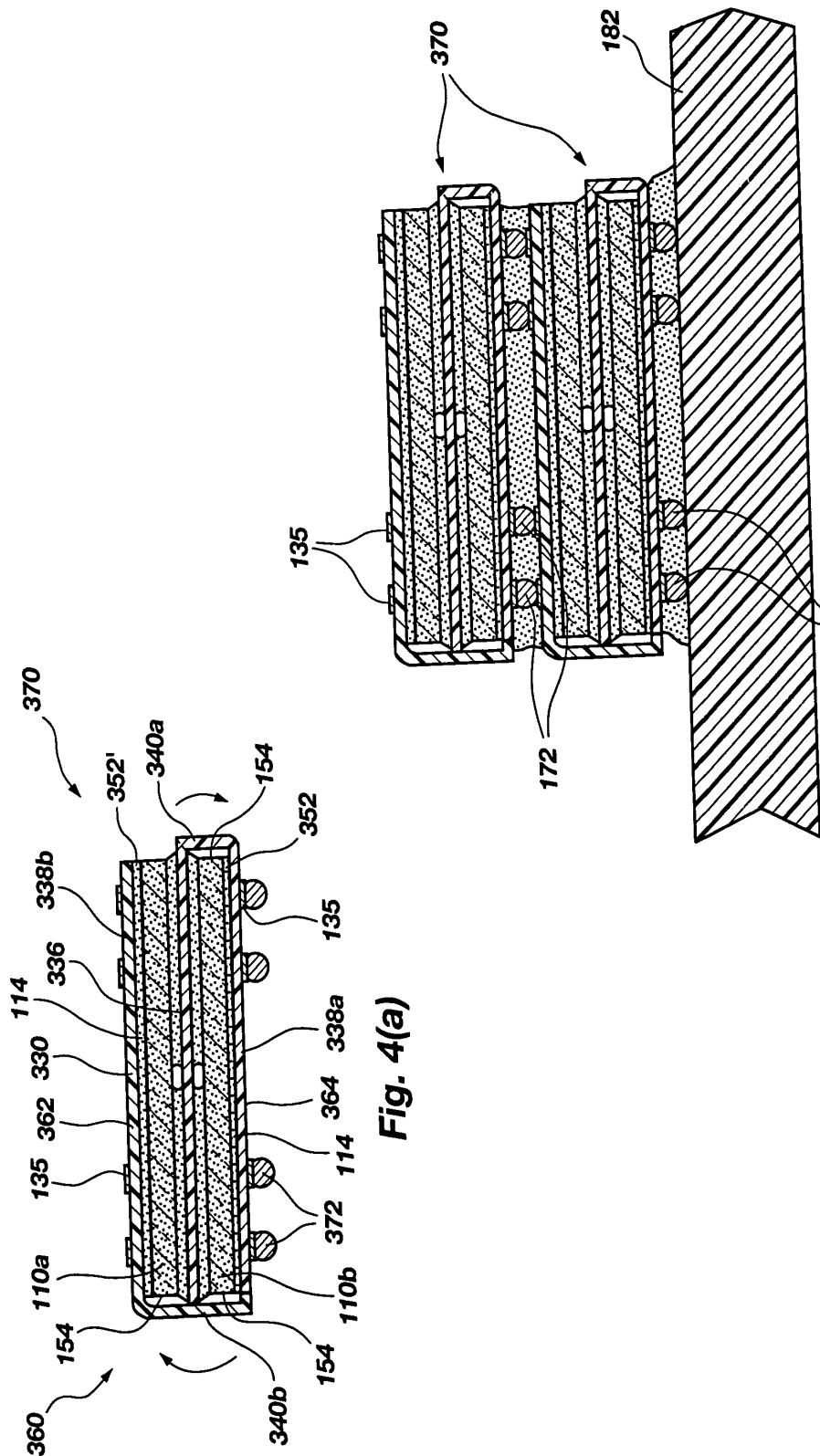


Fig. 4(a)

Fig. 4(b)